



# 150V 4.6mΩ TOLL N-Ch Power MOSFET

### Features

- Ultra-low ON-resistance,  $R_{DS(ON)}$
- Low Gate Charge,  $Q_g$
- 100% UIS and  $R_g$  Tested
- Pb-free Lead Plating
- Halogen-free and RoHS-compliant

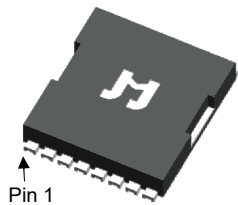
### Product Summary

Parameter	Value	Unit
$V_{DS}$	150	V
$V_{GS(th\_Typ)}$	3.2	V
$I_D$ (@ $V_{GS} = 10V$ ) <sup>(2)</sup>	159	A
$R_{DS(ON\_Typ)}$ (@ $V_{GS} = 10V$ )	4.6	mΩ

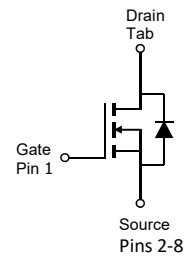
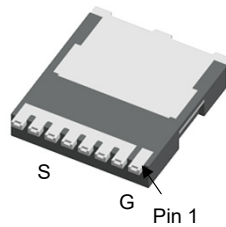
### Applications

- Power Management in Computing, CE, IE 4.0, Communications
- Current Switching in DC/DC & AC/DC (SR) Sub-systems
- Load Switching, Quick/Wireless Charging, Motor Driving

PowerJE<sup>®</sup>10x12 Top



PowerJE<sup>®</sup>10x12 Bottom



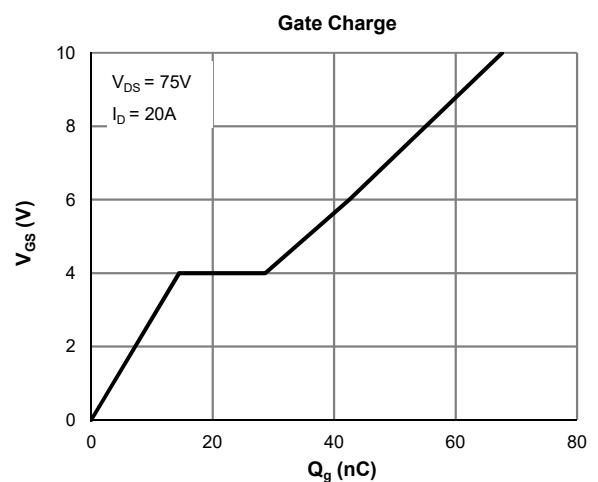
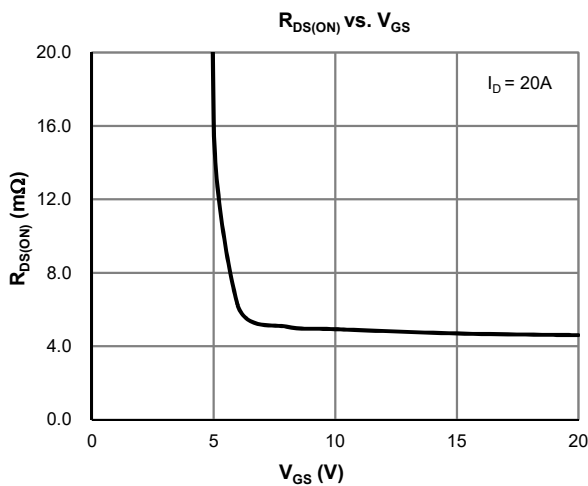
### Ordering Information

Device	Package	# of Pins	Marking	MSL	T <sub>J</sub> (°C)	Media	Quantity (pcs)
JMSH1505ATL-13	PowerJE <sup>®</sup> 10x12 <sup>(1)</sup>	8	SH1505A	1	-55 to 175	13-inch Reel	2000

Note 1: PowerJE<sup>®</sup> is a registered trademark of JieJie Micro., its package outline is compatible to that of TO-LeadLess (TOLL).

### Absolute Maximum Ratings (@ T<sub>A</sub> = 25°C unless otherwise specified)

Parameter	Symbol	Value	Unit
Drain-to-Source Voltage	$V_{DS}$	150	V
Gate-to-Source Voltage	$V_{GS}$	±20	V
Continuous Drain Current <sup>(2)</sup>	$I_D$	$T_C = 25^\circ C$	159
		$T_C = 100^\circ C$	113
Pulsed Drain Current <sup>(3)</sup>	$I_{DM}$	637	A
Avalanche Current <sup>(4)</sup>	$I_{AS}$	40	A
Avalanche Energy <sup>(4)</sup>	$E_{AS}$	800	mJ
Power Dissipation <sup>(5)</sup>	$P_D$	$T_C = 25^\circ C$	375
		$T_C = 100^\circ C$	188
Junction & Storage Temperature Range	$T_J, T_{STG}$	-55 to 175	°C





**Electrical Characteristics** (@  $T_J = 25^\circ\text{C}$  unless otherwise specified)

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
<b>STATIC PARAMETERS</b>						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$I_D = 250\mu\text{A}, V_{GS} = 0\text{V}$	150			V
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS} = 120\text{V}, V_{GS} = 0\text{V}$			1.0	$\mu\text{A}$
					5.0	
Gate-Body Leakage Current	$I_{GSS}$	$V_{DS} = 0\text{V}, V_{GS} = \pm 20\text{V}$			$\pm 100$	nA
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250\mu\text{A}$	2.5	3.2	4.5	V
Static Drain-Source ON-Resistance	$R_{DS(ON)}$	$V_{GS} = 10\text{V}, I_D = 20\text{A}$		4.6	5.8	$\text{m}\Omega$
Forward Transconductance	$g_{FS}$	$V_{DS} = 5\text{V}, I_D = 20\text{A}$		97		S
Diode Forward Voltage	$V_{SD}$	$I_S = 1\text{A}, V_{GS} = 0\text{V}$		0.67	1.0	V
Diode Continuous Current	$I_S$	$T_C = 25^\circ\text{C}$			375	A

**DYNAMIC PARAMETERS** <sup>(6)</sup>

Input Capacitance	$C_{iss}$	$V_{GS} = 0\text{V}, V_{DS} = 75\text{V}, f = 1\text{MHz}$		4320		pF
Output Capacitance	$C_{oss}$			535		pF
Reverse Transfer Capacitance	$C_{rss}$			7.2		pF
Gate Resistance	$R_g$	$V_{GS} = 0\text{V}, V_{DS} = 0\text{V}, f = 1\text{MHz}$		2.1		$\Omega$

**SWITCHING PARAMETERS** <sup>(6)</sup>

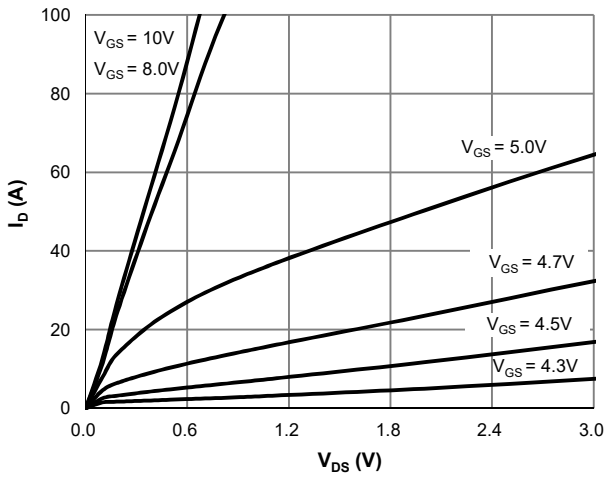
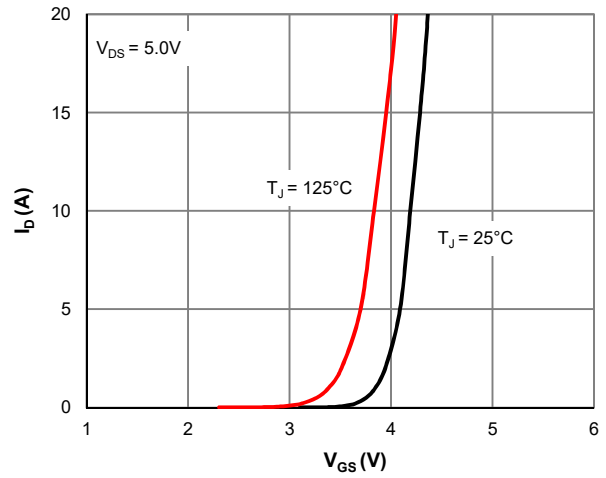
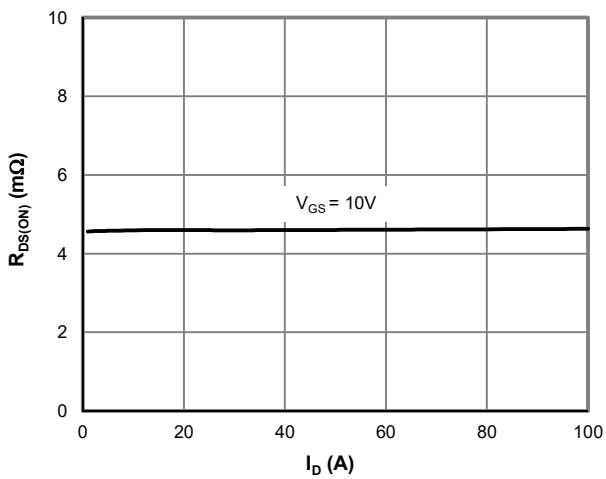
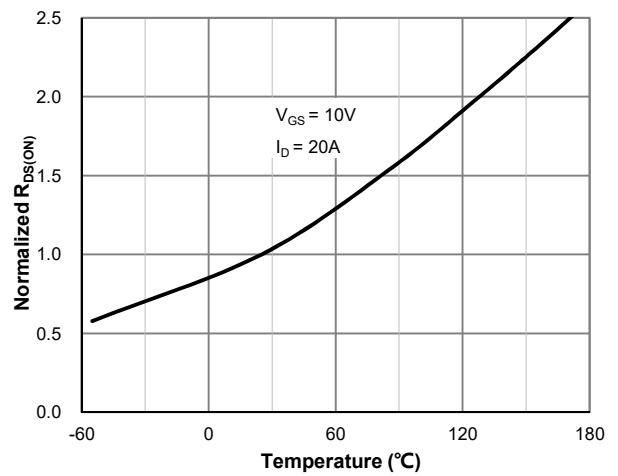
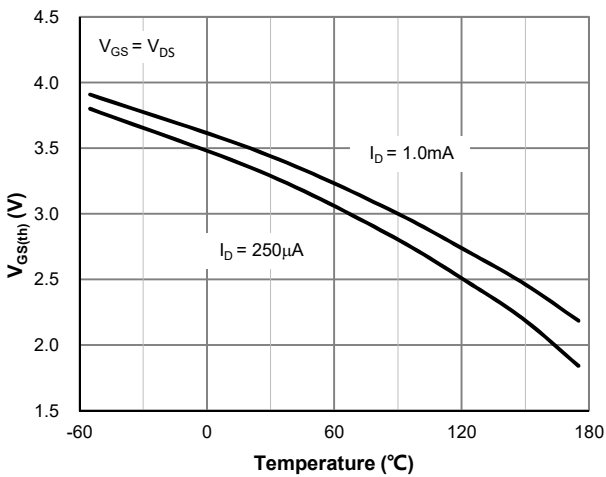
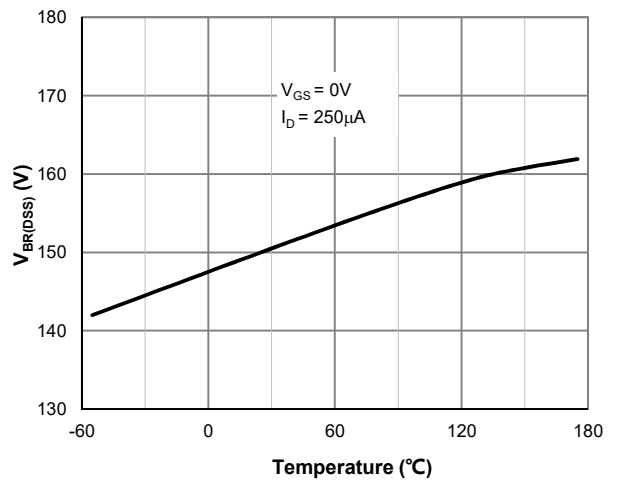
Total Gate Charge (@ $V_{GS} = 10\text{V}$ )	$Q_g$	$V_{GS} = 0 \text{ to } 10\text{V}$ $V_{DS} = 75\text{V}, I_D = 20\text{A}$		68		nC
Total Gate Charge (@ $V_{GS} = 6.0\text{V}$ )	$Q_g$			43		nC
Gate Source Charge	$Q_{gs}$			15.0		nC
Gate Drain Charge	$Q_{gd}$			14.0		nC
Turn-On DelayTime	$t_{D(on)}$	$V_{GS} = 10\text{V}, V_{DS} = 75\text{V}$ $R_L = 3.75\Omega, R_{GEN} = 6\Omega$		18.5		ns
Turn-On Rise Time	$t_r$			30		ns
Turn-Off DelayTime	$t_{D(off)}$			53		ns
Turn-Off Fall Time	$t_f$			41		ns
Body Diode Reverse Recovery Time	$t_{rr}$		$I_F = 20\text{A}, dI_F/dt = 100\text{A}/\mu\text{s}$		100	
Body Diode Reverse Recovery Charge	$Q_{rr}$	$I_F = 20\text{A}, dI_F/dt = 100\text{A}/\mu\text{s}$		150		nC

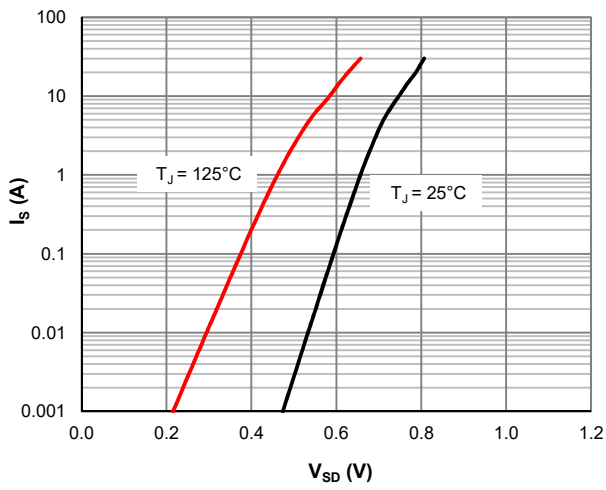
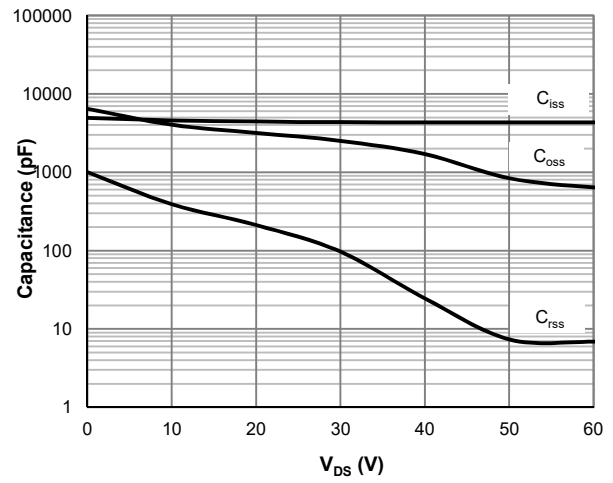
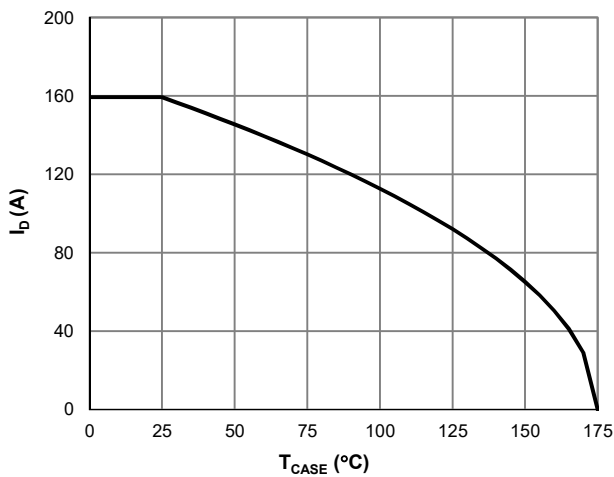
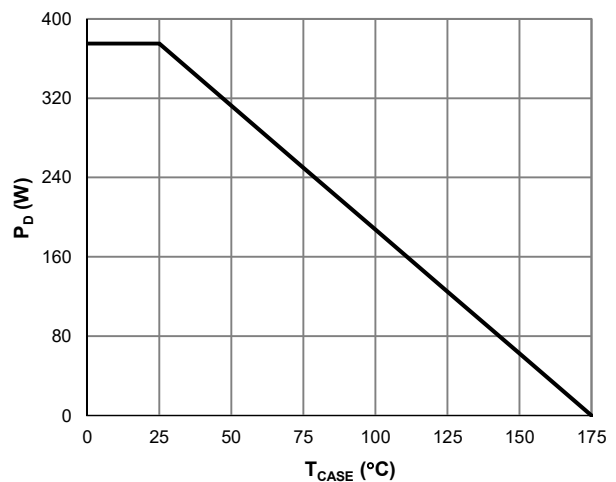
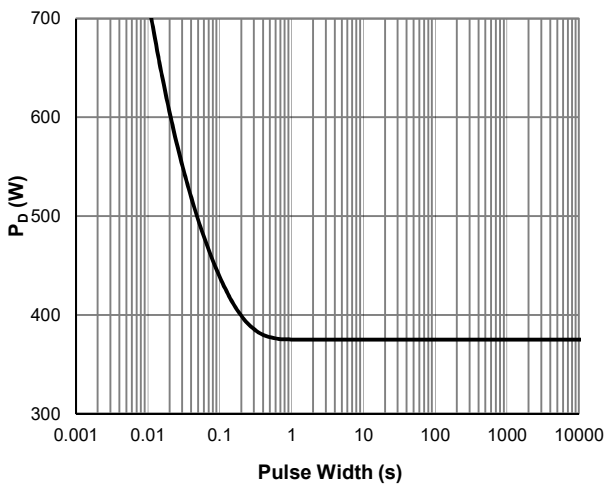
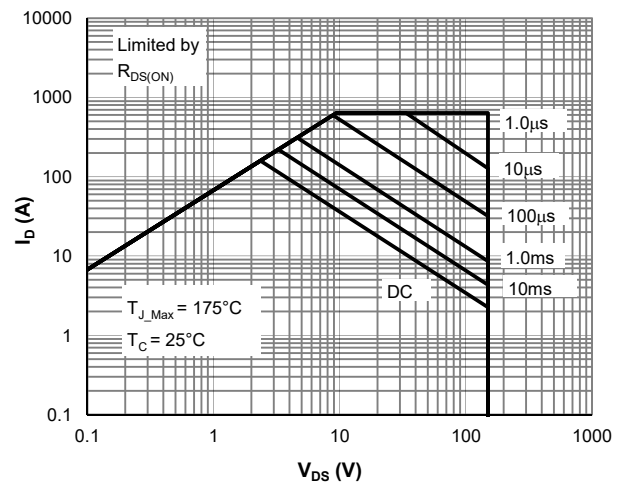
**Thermal Performance**

Parameter	Symbol	Typ.	Max.	Unit
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	45	55	$^\circ\text{C}/\text{W}$
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	0.40	0.50	$^\circ\text{C}/\text{W}$

**Notes:**

2. Computed continuous current assumes the condition of  $T_{J\_Max}$  while the actual continuous current depends on the thermal & electro-mechanical application board design.
3. This single-pulse measurement was taken under  $T_{J\_Max} = 175^\circ\text{C}$ .
4. This single-pulse measurement was taken under the following condition [ $L = 1\text{mH}, V_{GS} = 10\text{V}, V_{DD} = 75\text{V}$ ] while its value is limited by  $T_{J\_Max} = 175^\circ\text{C}$ .
5. The power dissipation  $P_D$  is based on  $T_{J\_Max} = 175^\circ\text{C}$ .
6. This value is guaranteed by design hence it is not included in the production test.

**Typical Electrical & Thermal Characteristics**

**Figure 1: Saturation Characteristics**

**Figure 2: Transfer Characteristics**

**Figure 3:  $R_{DS(ON)}$  vs. Drain Current**

**Figure 4:  $R_{DS(ON)}$  vs. Junction Temperature**

**Figure 5:  $V_{GS(th)}$  vs. Junction Temperature**

**Figure 6:  $V_{BR(DSS)}$  vs. Junction Temperature**

**Typical Electrical & Thermal Characteristics**

**Figure 7: Body-Diode Characteristics**

**Figure 8: Capacitance Characteristics**

**Figure 9: Current De-rating**

**Figure 10: Power De-rating**

**Figure 11: Single Pulse Power Rating, Junction-to-Case**

**Figure 12: Maximum Safe Operating Area**



### Typical Electrical & Thermal Characteristics

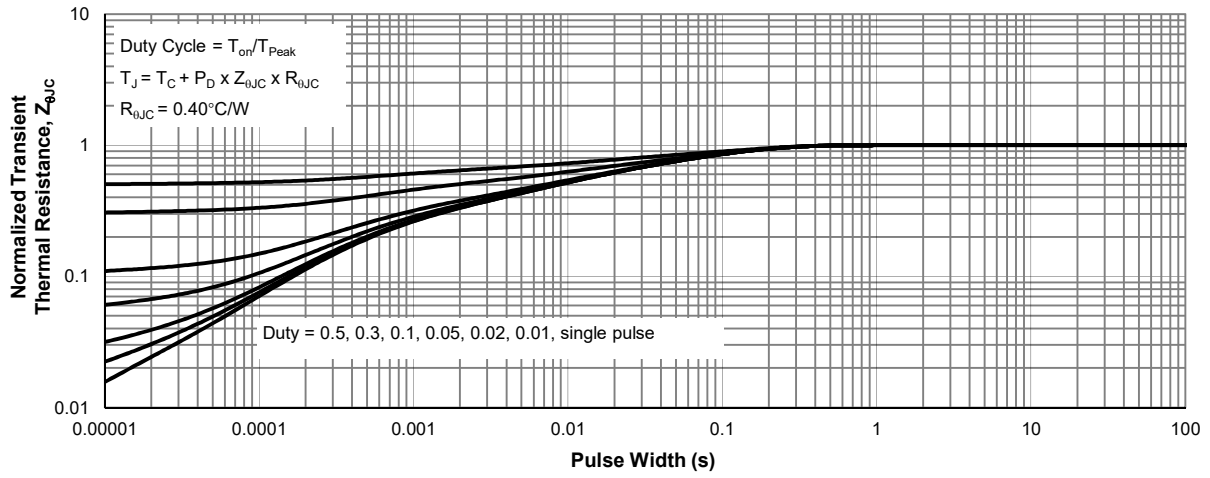
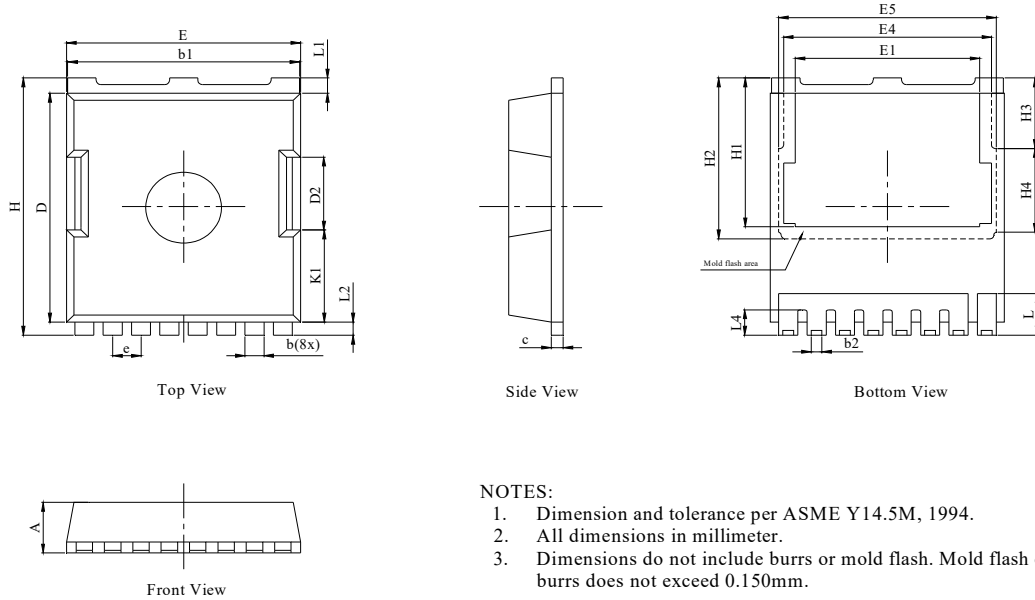


Figure 13: Normalized Maximum Transient Thermal Impedance

**PowerJE®10x12 Package Information**
**Package Outlines**

**NOTES:**

1. Dimension and tolerance per ASME Y14.5M, 1994.
2. All dimensions in millimeter.
3. Dimensions do not include burrs or mold flash. Mold flash or burrs does not exceed 0.150mm.

DIM.	MILLIMETER		
	MIN.	NOM.	MAX.
A	2.20	2.30	2.40
b	0.70	0.80	0.90
b1	9.70	9.80	9.90
b2	0.42	0.46	0.50
c	0.40	0.50	0.60
D	10.28	10.38	10.58
D2		3.30	
E	9.70	9.90	10.10
E1		7.80	
E4		8.80	
E5		9.20	
e		1.20 (BSC)	
H	11.48	11.68	11.88
H1	6.55	6.75	6.85
H2		7.30	
H3		3.20	
H4		3.80	
K1		4.18	
L	1.70	1.90	2.10
L1		0.70	
L2		0.60	
L4	1.00	1.15	1.30

**Recommended Soldering Footprint**
